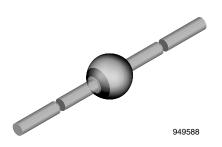


Vishay Semiconductors

FREE

Ultra Fast Avalanche Sinterglass Diode



FEATURES

- High reverse voltage
- · Glass passivated
- Low reverse current
- · Low forward voltage drop
- Hermetically sealed axial-leaded glass envelope
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

MECHANICAL DATA

Case: SOD-64

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

Mounting position: any **Weight:** approx. 858 mg

APPLICATIONS

- Switched mode power supplies
- High-frequency inverter circuits

PARTS TABLE				
PART	TYPE DIFFERENTIATION	PACKAGE		
BYV98-50	V _R = 50 V; I _{FAV} = 4 A	SOD-64		
BYV98-100	V _R = 100 V; I _{FAV} = 4 A	SOD-64		
BYV98-150	V _R = 150 V; I _{FAV} = 4 A	SOD-64		
BYV98-200	V _R = 200 V; I _{FAV} = 4 A	SOD-64		

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT	
Reverse voltage = repetitive peak reverse voltage	See electrical characteristics	BYV98-50	$V_R = V_{RRM}$	50	V	
		BYV98-100	$V_R = V_{RRM}$	100	V	
		BYV98-150	$V_R = V_{RRM}$	150	V	
		BYV98-200	$V_R = V_{RRM}$	200	V	
Peak forward surge current	t _p = 10 ms, half sine wave		I _{FSM}	70	Α	
Average forward current	T _{amb} = 30 °C, I = 10 mm		I _{FAV}	4	Α	
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C	
Non repetitive reverse avalanche energy	I _{(BR)R} = 1 A		E _R	20	mJ	

MAXIMUM THERMAL RESISTANCE (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Junction ambient	Lead length I = 10 mm, T _L = constant	R _{thJA}	25	K/W	

BYV98-50, BYV98-100, BYV98-150, BYV98-200

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Ultra Fast Avalanche Sinterglass Diode



ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 5 A		V_{F}	-	-	1.1	V
Reverse current	$V_R = V_{RRM}$		I _R	-	-	10	μA
	$V_R = V_{RRM}$, $T_j = 150$ °C		I _R	-	-	200	μA
Reverse breakdown voltage	I _R = 100 μA	BYV98-50	V _{(BR)R}	60	-	-	V
		BYV98-100	V _{(BR)R}	120	-	-	V
		BYV98-150	V _{(BR)R}	170	-	-	V
		BYV98-200	V _{(BR)R}	220	-	-	V
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, i_R = 0.25 \text{ A}$		t _{rr}	-	-	35	ns

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

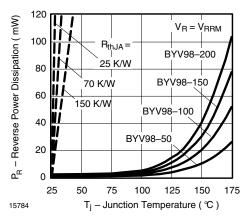


Fig. 1 - Max. Reverse Power Dissipation vs. Junction Temperature

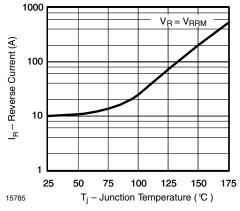


Fig. 2 - Max. Reverse Current vs. Junction Temperature

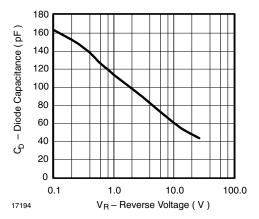


Fig. 3 - Diode Capacitance vs. Reverse Voltage

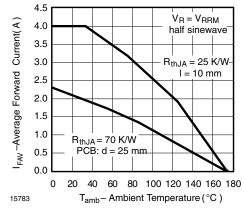


Fig. 4 - Max. Average Forward Current vs. Ambient Temperature



Ultra Fast Avalanche Sinterglass Diode Vishay Semiconductors

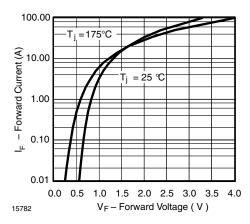
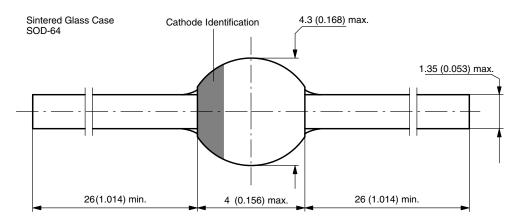


Fig. 5 - Max. Forward Current vs. Forward Voltage

PACKAGE DIMENSIONS in millimeters (inches): SOD-64



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94 9587





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